



Serial No. 10/665,630  
Attorney Docket No. SEC.1064  
Amendment filed July 5, 2005

*IN THE UNITED STATES PATENT AND TRADEMARK OFFICE*

In re Patent application of : **Mail Stop Amendment**  
Hyeong-Seob Kim et al. : Group Art Unit 2818  
Serial No. 10/665,630 : Examiner Andy Huynh  
Filed September 22, 2003 :  
Title: WAFER LEVEL PACKAGE, MULTI-PACKAGE STACK, AND METHOD OF  
MANUFACTURING THE SAME

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**AMENDMENT**

U.S. Patent and Trademark Office  
Customer Service Window, **Mail Stop Amendment**  
Randolph Building  
401 Dulany Street  
Alexandria VA 22314

Sir:

In response to the Office Action of March 2, 2005, please amend the above-identified application as follows:

**Amendments to the Drawings** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks/Arguments** begin on page 11 of this paper.

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